# **Tyrone Camarero Specifications**

# **Tyrone**

## Camarero SDI100A3TB-26

### **Key features**

Hyperconverged Infrastructure, Scale-Out Object Storage, Back-up & Recovery Two hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Dual Socket P+ (LGA 4189), 3rd Gen Intel® Xeon® Scalable processors,
   Support CPU TDP 250W,36C/72T Note: Certain CPUs with high TDP may be supported only under specific conditions. Please contact Tyrone Technical Support for additional information about specialized system optimization
- Intel® C621A
- 20 DIMM Slots (16 DIMM Slots + 4 Intel® Optane™ Persistent Memory Slots)
- 1 PCI-E 4.0 x16 (LP) slot; 2 PCI-E 4.0 x8 (LP) slot; Tool-less support, Internal PCI-E 3.0 x8 for 2 M.2 NVMe/SATA support onboard, Optional NVMe Boot Controller via AOC-SMG3-2M2-B
- Network connectivity via AIOM (OCP 3.0 compliant)
- 6 Hot-swap 3.5" drive bays; 6 PCI-E 4.0 NVMe/SATA 3.5" drives
- 2 cooling fans per node, 14.9K RPM Liquid Cooling Support
- 2200W Redundant Power Supplies Titanium Level (96%+); Shared Power Design





#### Processor/Cache

Processor

Dual Socket P+ (LGA 4189), 3rd Gen Intel® Xeon®

Scalable processors, Support CPU TDP 250W,36C/72T Note: Certain CPUs with high TDP may be supported only under specific conditions. Please contact Tyrone Technical Support for additional information about

specialized system optimization

Chipset

Chipset Intel® C621A

System Memory

**Memory Capacity** 

20 DIMM Slots (16 DIMM Slots + 4 Intel® Optane™ Persistent Memory Slots)

**Expansion Slots** 

**PCI-Express** 

Slot 1: PCI-E 4.0 x8 LP, Slot 2: PCI-E 4.0 x8 LP , Slot 3: PCI-E 4.0 x16 LP, Internal Slot: M.2

**Integrated Onboard** 

IPMI Support for Intelligent Platform Management

Interface v.2.0, IPMI 2.0 with virtual media over

LAN and KVM-over-LAN support 1 RJ45 Dedicated BMC LAN port

USB 2 USB 3.0 port(s) (2 rear)

Add-on Options

IAN

Raid Card: None
Optical Drive: None

**Front Panel** 

LEDs HDD activity LED, Network activity LEDs, Power status

LED, Universal Information (UID) LED

Buttons Power On/Off button, UID button

**Drive Bays** 

HDD Bays 6x 3.5" hot-swap NVMe/SATA drive bays

(6x 2.5" NVMe hybrid; 6x 3.5" NVMe hybrid)

**Power Supply** 

2200W Redundant Power Supplies Titanium Level (96%+); Shared Power Design

Cooling System

4x 14.9K RPM Heavy Duty 8cm Fan(s)

**Form Factor** 

Form Factor 2U Rackmount

Dimensions: Height: 3.47"" (88mm),

Width:17.68"" (449mm), Depth:30.5"" (774mm)

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For more/current product information, visit

www.tyronesystems.com

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